

NOT RECOMMENDED FOR NEW DESIGN **USE ZXTP2014G**

DPLS4140E



LOW $V_{CE(SAT)}$ PNP SURFACE MOUNT TRANSISTOR

Features

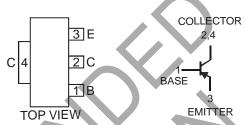
- **Epitaxial Planar Die Construction**
- Ideally Suited for Automated Assembly Processes
- Ideal for Medium Power Switching or Amplification Applications
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

Mechanical Data

- Case: SOT-223
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Matte Tin annealed over Copper Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.115 grams (approximate)



SOT-223



Schematic and Pin Configuration

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-180	V
Collector-Emitter Voltage	V_{CEO}	-140	V
Emitter-Base Voltage	V_{EBO}	-7	V
Continuous Collector Current	Ic	-4	Α
Peak Pulse Current	I _{CM}	-10	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3) @ T _A = 25°C	P _D	1	W
Thermal Resistance, Junction to Ambient Air (Note 3) @ T _A = 25°C	$R_{ heta JA}$	125	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

- No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

 Device mounted on FR-4 PCB; pad layout as shown on page 4 or in Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.



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Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 4)						
Collector-Base Breakdown Voltage	V _{(BR)CBO}	-180	-230		V	$I_C = -100 \mu A, I_E = 0$
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	-140	-190		V	$I_C = -10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	-7	-8.5	_	V	$I_E = -100 \mu A, I_C = 0$
Collector Cutoff Current	Ісво	_	_	-20 -0.5	nA μA	$V_{CB} = -150V, I_{E} = 0$ $V_{CB} = -150V, I_{E} = 0,$ $T_{A} = 100^{\circ}C$
Emitter Cutoff Current	I _{EBO}	_	_	-10	nA	$V_{EB} = -6V, I_{C} = 0$
ON CHARACTERISTICS (Note 4)						
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	_ _ _	-40 -50 -75 -175	-60 -80 -120 -360	mV	$I_C = -0.1A$, $I_B = -5mA$ $I_C = -0.5A$, $I_B = -50mA$ $I_C = -1A$, $I_B = -100mA$ $I_C = -3A$, $I_B = -300mA$
Base-Emitter Saturation Voltage	V _{BE(SAT)}	_	-910	-1040	mV	$I_C = -3A$, $I_B = -300mA$
Base-Emitter Turn-On Voltage	V _{BE(ON)}	_	-810	-930	mV	I _C = -3A, V _{CE} = -5V
DC Current Gain	h _{FE}	100 100 45 —		300 — —		$I_C = -10mA$, $V_{CE} = -5V$ $I_C = -1A$, $V_{CE} = -5V$ $I_C = -3A$, $V_{CE} = -5V$ $I_C = -10A$, $V_{CE} = -5V$
SMALL SIGNAL CHARACTERISTICS						
Current Gain-Bandwidth Product	f _T		150		MHz	$I_C = -100 \text{mA}, V_{CE} = -10 \text{V},$ f = 100MHz
Output Capacitance	Cobo		55		pF	$V_{CB} = -10V$, $f = 1MHz$
SWITCHING CHARACTERISTICS						
Switching Times	t _{on}		85 430		ns	$I_C = -1A$, $I_{B1} = -100$ mA $I_{B2} = 100$ mA, $V_{CC} = -50$ V

Notes: 4. Measured under pulsed conditions. Pulse width = 300μ s. Duty cycle $\leq 2\%$

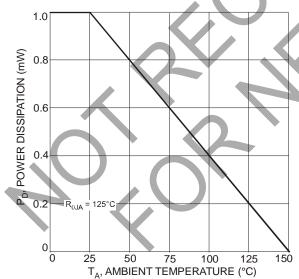


Fig. 1 Max Power Dissipation vs. Ambient Temperature

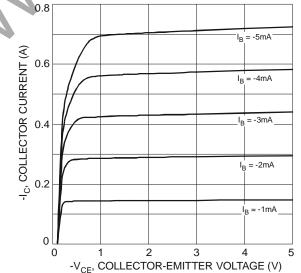


Fig. 2 Typical Collector Current vs. Collector-Emitter Voltage



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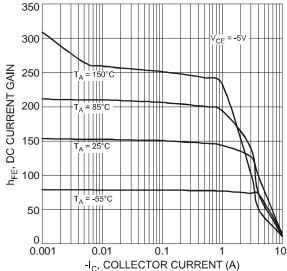


Fig. 3 Typical DC Current Gain vs. Collector Current

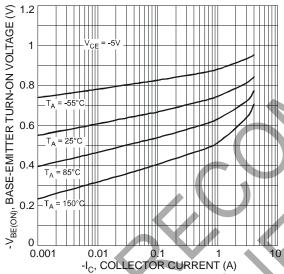


Fig. 5 Typical Base-Emitter Turn-On Voltage vs. Collector Current

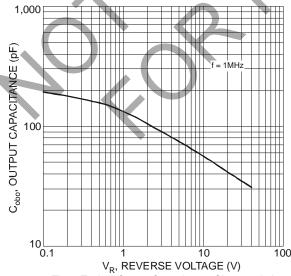
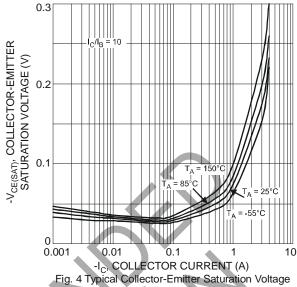


Fig. 7 Typical Output Capacitance Characteristics



vs. Collector Current

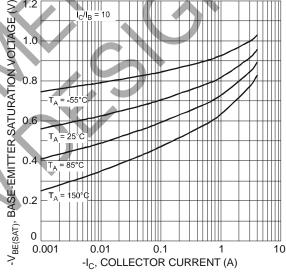


Fig. 6 Typical Base-Emitter Saturation Voltage vs. Collector Current

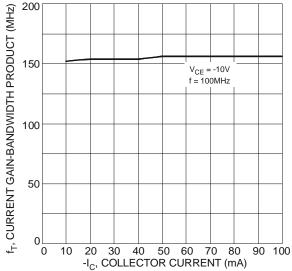


Fig. 8 Typical Gain-Bandwidth Product vs. Collector Current



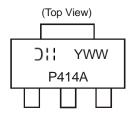
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Ordering Information (Note 5)

Device	Packaging	Shipping	
DPLS4140E -13	SOT-223	2500/Tape & Reel	

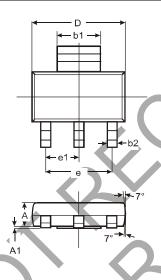
Notes: 5. For packaging details, go to our website at http://www.diodes.com/ap02007.pdf.

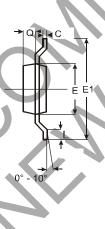
Marking Information



P414A = Product Type Marking Code YWW = Date Code Marking Y = Last digit of year ex: 7 = 2007 WW = Week code 01 - 52

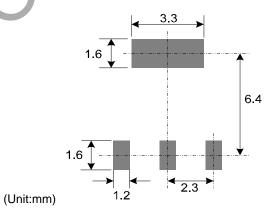
Package Outline Dimensions





SOT-223					
Dim	Min	Max	Тур		
A	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b1	2.90	3.10	3.00		
b2	0.60	0.80	0.70		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
E	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е		_	4.60		
e1		_	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					

Suggested Pad Layout:





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